Plastic Body: LCP, Color Black.
Contact: Phosphor Bronze Alloy (C5191R-H)
Contact area: Gold 3 micro inches
Solder area: Matte Tin
All under-plated Ductile Nickel 50 micro inches (Min.)
Latch: SUS304R-1/2H, Matte Tin Plated
Contact Resistance: 30 mΩ (Max)
Insulation Resistance: 500 MΩ (Max.)
Dielectric Withstanding Voltage:
Mate connectors; apply 250V AC at 60 Hz (rms.)
Contact Normal Force: 50 gf per pin (Min.)
soldering heat: 260°C
Rating Voltage: 25V AC
Rating Current: 0.3A (Max.)/(1PIN)
Operating Temperature: -40°C to +90°C
Storage Temperature: -40°C to +90°C

1. Standoff
   s/o 9.2mm

2. Contact Plating
   B3u' Gold Plating

3. Color
   Black

4. RoHS

ATTEND TECHNOLOGY INC.

FILE NAME: 1148-92800-R02_8_2
PRODUCT NO.: 1148-92800-R02
DRAWN NAME: Mini PCI Socket
stand off 9.2mm, Metal grounding type

DRAWN: Willis 2009/09/28
CHECKED: Angel 2009/09/28
APPROVED: Ken 2009/09/28
RECOMMEND PC BOARD LAYOUT

MINI PCI SOCKET

Stand off 0.2mm, Metal grounding type
NOTES:
1. PACKING STYLE 20 PCS/TRAY
   160 PCS/INNER CARTON
   640 PCS/OUTER CARTON
2. MATERIAL TRAY: PET

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